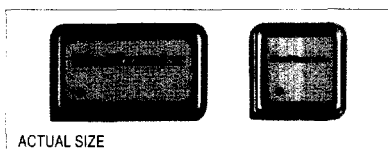
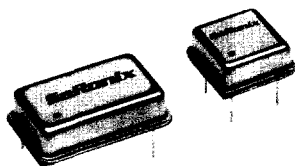


### Technical Data

NTH / NCH Series



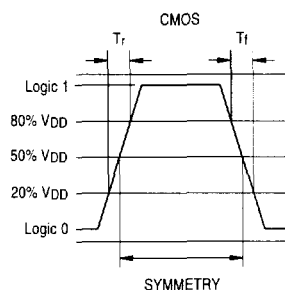
#### Description

A crystal controlled, low current, low jitter and high frequency oscillator with precise rise and fall times demanded in networking applications, such as Gigabit Ethernet and Fibre Channel. The tri-state function on the NTH enables the output to go high impedance. Device is packaged in a 14 or an 8-pin DIP compatible resistance welded, all metal grounded case, to reduce EMI.

#### Applications & Features

- Gigabit Ethernet
- Fibre Channel
- 32 Bit Microprocessors
- Tri-State output on NTH
- HCMOS compatible
- Available up to 106.25 MHz
- Grounded, all metal, full or half size packages, gull wing leads available
- Plastic SMD available, see separate data sheet

#### Output Waveform



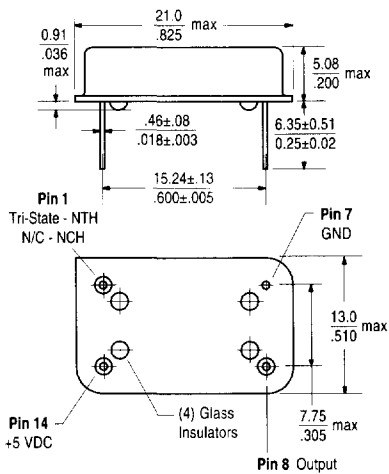
<b>Frequency Range:</b>	1 MHz to 106.25 MHz
<b>Frequency Stability:</b>	±25, ±50 or ±100 ppm over all conditions: calibration tolerance, operating temperature, input voltage change, load change, 30 day aging, shock and vibration.
<b>Temperature Range:</b>	Operating: 0 to +70°C or -40 to +85°C, See Part Numbering Guide Storage: -55 to +125°C
<b>Supply Voltage:</b>	Recommended Operating: 3.3V ±10%
<b>Supply Current:</b>	Frequency: 1 to 27 MHz 15mA max 27+ to 80 MHz 25mA max 80+ to 106.25 MHz 35mA max
<b>Output Drive:</b>	<b>HCMOS</b> Symmetry: 40/60% or 45/55% max @ 50% VDD, See Part Numbering Guide Rise and Fall Times: 4ns max 20% to 80% VDD to 80 MHz 2ns max 80+ to 106.25 MHz Logic 0: 10% VDD max Logic 1: 90% VDD min Load: 30 pF, 1 to 80 MHz Load: 15pF, 80+ to 106.25 MHz Period Jitter RMS: 8ps max
<b>Mechanical:</b>	Shock: MIL-STD-883, Method 2002, Condition B Solderability: MIL-STD-883, Method 2003 Terminal Strength: MIL-STD-202, Method 211, Conditions A & C Vibration: MIL-STD-883, Method 2007, Condition A Solvent Resistance: MIL-STD-202, Method 215 Resistance to Soldering Heat: MIL-STD-202, Method 210, Condition A, B or C
<b>Environmental:</b>	Gross Leak Test: MIL-STD-883, Method 1014, Condition C Fine Leak Test: MIL-STD-883, Method 1014, Condition A2 Thermal Shock: MIL-STD-883, Method 1011, Condition A Moisture Resistance: MIL-STD-883, Method 1004

### Technical Data

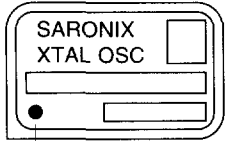
### NTH / NCH Series

#### Package Details

##### FULL SIZE PACKAGE

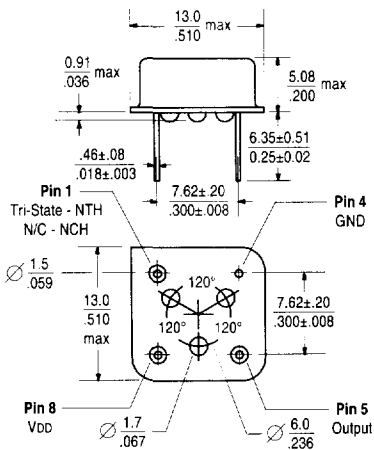


**Standard Marking Format\*\***  
Includes Date Code, Frequency & Model



Denotes Pin 1

##### HALF SIZE PACKAGE



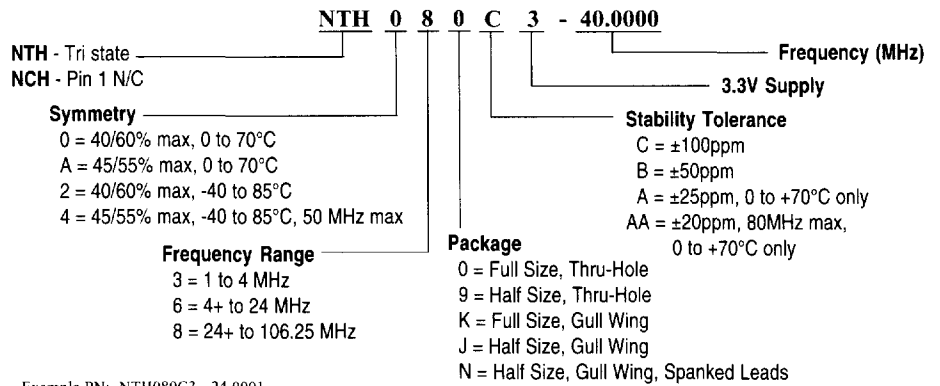
**Standard Marking Format\*\***  
Includes Date Code, Frequency & Model



Denotes Pin 1

\*\*Exact location of items may vary

#### Part Numbering Guide



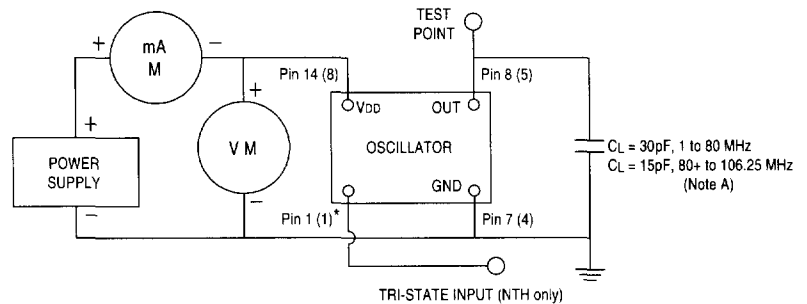
Example PN: NTH080C3 - 24.0001

#### Tri-State Logic Table (NTH only)

Pin 1 Input	Pin 8 (5) Output
Logic 1 or NC	Oscillation
Logic 0 or GND	High Impedance

Required Input Levels on Pin 1:  
Logic 1 = 2.2V min  
Logic 0 = 0.8V max

#### Test Circuit



NOTE A:  $C_L$  includes probe and fixture capacitance  
( ) Indicates pin numbers for half-size package

All specifications are subject to change without notice.